



## BAS16 / MMBD4148 / MMBD914

#### SURFACE MOUNT SWITCHING DIODE

#### **Features**

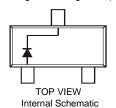
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- **High Conductance**
- Qualified to AEC-Q101 Standards for High Reliability
- Lead, Halogen and Antimony Free, RoHS Compliant "Green' Device (Notes 3 and 4)

### **Mechanical Data**

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)



TOP VIEW



### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	53	V
Forward Continuous Current (Note 1)	I <sub>FM</sub>	300	mA
Average Rectified Output Current (Note 1)	I <sub>0</sub>	200	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

SOT-23

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P <sub>D</sub>	350	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta}$ JA	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

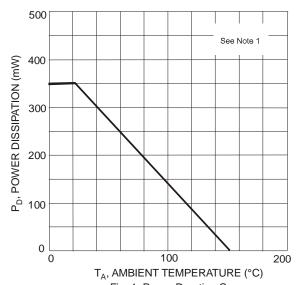
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

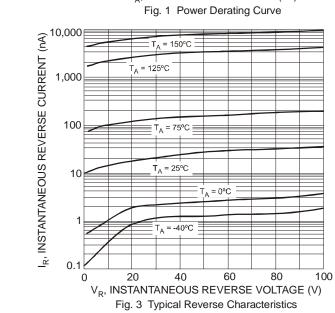
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	75	_	V	$I_R = 100 \mu A$
Forward Voltage	V <sub>F</sub>	_	0.715 0.855 1.0 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 2)	I <sub>R</sub>	_	1.0 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$ , $T_J = 150$ °C $V_R = 25V$ , $T_J = 150$ °C $V_R = 20V$
Total Capacitance	C <sub>T</sub>	_	2.0	pF	$V_R = 0$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

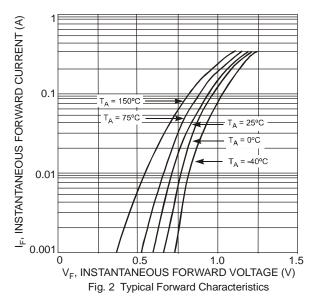
Device mounted on glass epoxy PCB 1.6" x 1.6" x 0.06"; mounting pad for the cathode lead min. 0.93in<sup>2</sup>. Notes:

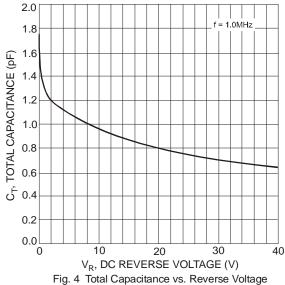
- Short duration pulse test used to minimize self-heating effect.
- No purposefully added lead. Halogen and Antimony Free.
- Product manufactured with Data Čode V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









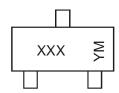


## Ordering Information (Note 5)

Part Number	Case	Packaging
BAS16-7-F	SOT-23	3000/Tape & Reel
MMBD4148-7-F	SOT-23	3000/Tape & Reel
MMBD914-7-F	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



XXX = Product Type Marking Code (KA6, KA2, K5D) YM = Date Code Marking Y = Year ex: N = 2002

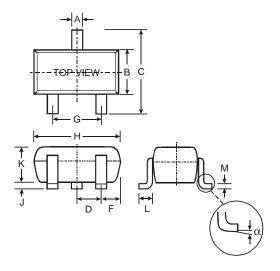
M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	N	Р	R	S	Т	U	V	W	Χ	Υ	Z
Month	Jan	Fe	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Ос	t	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

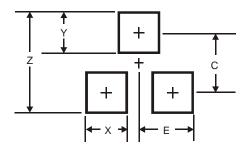


## **Package Outline Dimensions**



SOT-23					
Dim	Min	Max			
Α	0.37	0.51			
В	1.20	1.40			
С	2.30	2.50			
D	0.89	1.03			
F	0.45 0.60				
G	1.78	2.05			
Н	2.80 3.00				
J	<b>J</b> 0.013 0.10				
K	<b>K</b> 0.903 1.10				
L	0.45 0.61				
М	0.085 0.180				
α	α 0° 8°				
All Dimensions in mm					

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35

#### IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

#### LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.